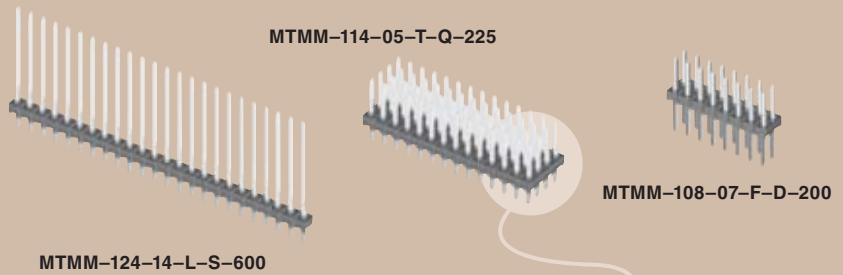




(2,00 mm) .0787"

MTMM SERIES



MODIFIED THROUGH-HOLE HEADER

SPECIFICATIONS

For complete specifications see www.samtec.com?MTMM

Insulator Material:
Black Liquid Crystal Polymer



Terminal Material:
Phosphor Bronze

Plating:
Sn or Au over 50µ" (1,27 µm) Ni

Current Rating:
3A per contact @ 80°C ambient

Operating Temp Range:
-55°C to +105°C with Tin;
-55°C to +125°C with Gold

RoHS Compliant:
Yes

Lead-Free Solderable:
Yes

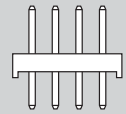
Mates with:
CLT, SQT, SQW, ESQT,
TLE, SMM, MMS, TCSD



Choice of single, double or quad row

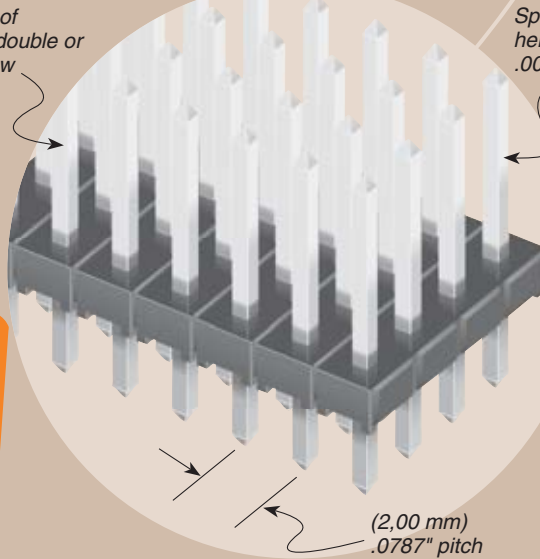
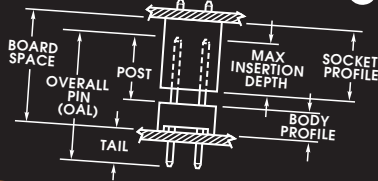
Specify post height in (0,13 mm) .005" increments

ALSO AVAILABLE



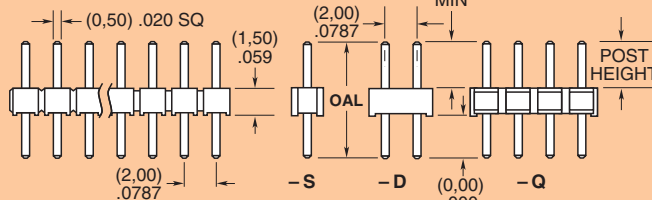
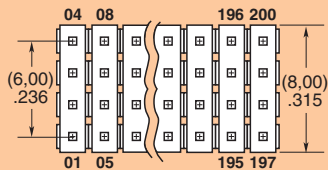
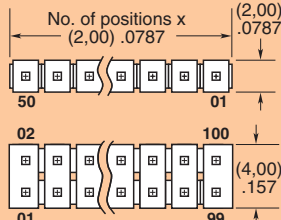
Paste In Hole (PIH) processing. Contact Samtec ASP Group.

Board Stacking



MTMM - **1** NO. PINS PER ROW - **LEAD STYLE** - **PLATING OPTION** - **ROW OPTION** - **POST HEIGHT** - **OPTION**

01 thru 50



Specify LEAD STYLE from chart.

- F = Gold flash on post, Matte Tin on tail
- L = 10µ" (0,25 µm) Gold post, Matte Tin on tail
- T = Matte Tin

Note:
Other Gold plating options available. Contact Samtec.

- S = Single Row
- D = Double Row
- Q = Quad Row

- "XXX"
= Post Height in inches (0,13 mm) .005" increments
Example:
-070 = (1,78 mm) .070"

- "XXX"
= Polarized Position
Specify position of omitted pin

LEAD STYLE	OAL
-02	(6,48) .255
-03	(7,67) .302
-04	(8,20) .323
-05	(9,58) .377
-06	(10,08) .397
-07	(11,58) .456
-08	(12,09) .476
-09	(13,59) .535
-10	(14,10) .555
-11	(15,09) .594
-12	(15,60) .614
-13	(17,09) .673
-14	(19,08) .751
-15	(21,08) .830

Note: This Series is non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM